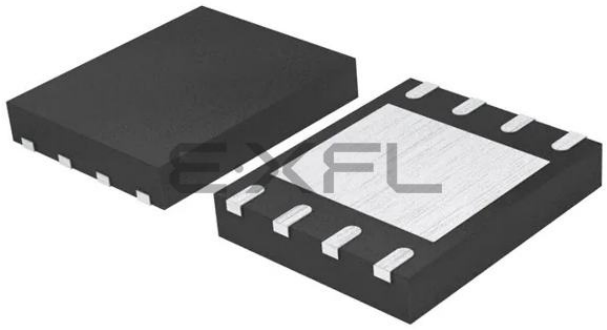

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	eZ8
Core Size	8-Bit
Speed	5MHz
Connectivity	IrDA, UART/USART
Peripherals	Brown-out Detect/Reset, LED, POR, PWM, WDT
Number of I/O	6
Program Memory Size	1KB (1K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	8-VDFN Exposed Pad
Supplier Device Package	8-QFN (5x6)
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f0113qb005sc

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Pin Description

Z8 Encore! XP® F0823 Series products are available in a variety of package styles and pin configurations. This chapter describes the signals and pin configurations available for each of the package styles. For information on physical package specifications, see Packaging on page 209.

Available Packages

Table 2 lists the package styles that are available for each device in the Z8 Encore! XP F0823 Series product line.

Table 2. Z8 Encore! XP F0823 Series Package Options

Part Number	ADC	8-pin PDIP	8-pin SOIC	20-pin PDIP	20-pin SOIC	20-pin SSOP	28-pin PDIP	28-pin SOIC	28-pin SSOP	8-pin QFN/ MLF-S
Z8F0823	Yes	X	X	X	X	X	X	X	X	X
Z8F0813	No	X	X	X	X	X	X	X	X	X
Z8F0423	Yes	X	X	X	X	X	X	X	X	X
Z8F0413	No	X	X	X	X	X	X	X	X	X
Z8F0223	Yes	X	X	X	X	X	X	X	X	X
Z8F0213	No	X	X	X	X	X	X	X	X	X
Z8F0123	Yes	X	X	X	X	X	X	X	X	X
Z8F0113	No	X	X	X	X	X	X	X	X	X

Pin Configurations

Figure 2 through Figure 4 displays the pin configurations for all packages available in the Z8 Encore! XP F0823 Series. For description of signals, see Table 3. The analog input alternate functions (ANA*x*) are not available on the Z8F0x13 devices. The analog supply pins (AV_{DD} and AV_{SS}) are also not available on these parts, and are replaced by PB6 and PB7.

At reset, all pins of Ports A, B, and C default to an input state. In addition, any alternate functionality is not enabled, so the pins function as general-purpose input ports until programmed otherwise.

Register Map

Table 8 lists the address map for the Register File of the Z8 Encore! XP® F0823 Series devices. Not all devices and package styles in the Z8 Encore! XP F0823 Series support the ADC, or all GPIO ports. Consider registers for unimplemented peripherals as reserved.

Table 8. Register File Address Map

Address (Hex)	Register Description	Mnemonic	Reset (Hex)	Page No
General-Purpose RAM				
Z8F0823/Z8F0813 Devices				
000–3FF	General-Purpose Register File RAM	—	XX	
400–EFF	Reserved	—	XX	
Z8F0423/Z8F0413 Devices				
000–3FF	General-Purpose Register File RAM	—	XX	
400–EFF	Reserved	—	XX	
Z8F0223/Z8F0213 Devices				
000–1FF	General-Purpose Register File RAM	—	XX	
200–EFF	Reserved	—	XX	
Z8F0123/Z8F0113 Devices				
000–0FF	General-Purpose Register File RAM	—	XX	
100–EFF	Reserved	—	XX	
Timer 0				
F00	Timer 0 High Byte	T0H	00	80
F01	Timer 0 Low Byte	T0L	01	80
F02	Timer 0 Reload High Byte	T0RH	FF	81
F03	Timer 0 Reload Low Byte	T0RL	FF	81
F04	Timer 0 PWM High Byte	T0PWMH	00	81
F05	Timer 0 PWM Low Byte	T0PWML	00	82
F06	Timer 0 Control 0	T0CTL0	00	82
F07	Timer 0 Control 1	T0CTL1	00	83
Timer 1				
F08	Timer 1 High Byte	T1H	00	80
F09	Timer 1 Low Byte	T1L	01	80
F0A	Timer 1 Reload High Byte	T1RH	FF	81
F0B	Timer 1 Reload Low Byte	T1RL	FF	81

Table 19. Port A–C Control Registers (P*x*CTL)

BITS	7	6	5	4	3	2	1	0
FIELD	PCTL							
RESET	00H							
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	FD1H, FD5H, FD9H							

PCTL[7:0]—Port Control
The Port Control register provides access to all sub-registers that configure the GPIO Port operation.

Port A–C Data Direction Sub-Registers

The Port A–C Data Direction sub-register is accessed through the Port A–C Control register by writing 01H to the Port A–C Address register (Table 20).

Table 20. Port A–C Data Direction Sub-Registers (PxDD)

BITS	7	6	5	4	3	2	1	0
FIELD	DD7	DD6	DD5	DD4	DD3	DD2	DD1	DD0
RESET	1	1	1	1	1	1	1	1
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	If 01H in Port A–C Address Register, accessible through the Port A–C Control Register							

DD[7:0]—Data Direction
These bits control the direction of the associated port pin. Port Alternate Function operation overrides the Data Direction register setting.
0 = Output. Data in the Port A–C Output Data register is driven onto the port pin.
1 = Input. The port pin is sampled and the value written into the Port A–C Input Data Register. The output driver is tristated.

Port A–C Alternate Function Sub-Registers

The Port A–C Alternate Function sub-register (Table 21) is accessed through the Port A–C Control register by writing `02H` to the Port A–C Address register. The Port A–C Alternate Function sub-registers enable the alternate function selection on pins. If disabled, pins functions as GPIO. If enabled, select one of four alternate functions using alternate function set subregisters 1 and 2 as described in the Port A–C Alternate Function Set 1 Sub-Registers on page 48 and Port A–C Alternate Function Set 2 Sub-Registers on

Infrared Encoder/Decoder

Z8 Encore! XP® F0823 Series products contain a fully-functional, high-performance UART with Infrared Encoder/Decoder (Endec). The Infrared Endec is integrated with an on-chip UART to allow easy communication between the Z8 Encore! XP and IrDA Physical Layer Specification, Version 1.3-compliant infrared transceivers. Infrared communication provides secure, reliable, low-cost, point-to-point communication between PCs, PDAs, cell phones, printers and other infrared enabled devices.

Architecture

Figure 16 displays the architecture of the Infrared Endec.

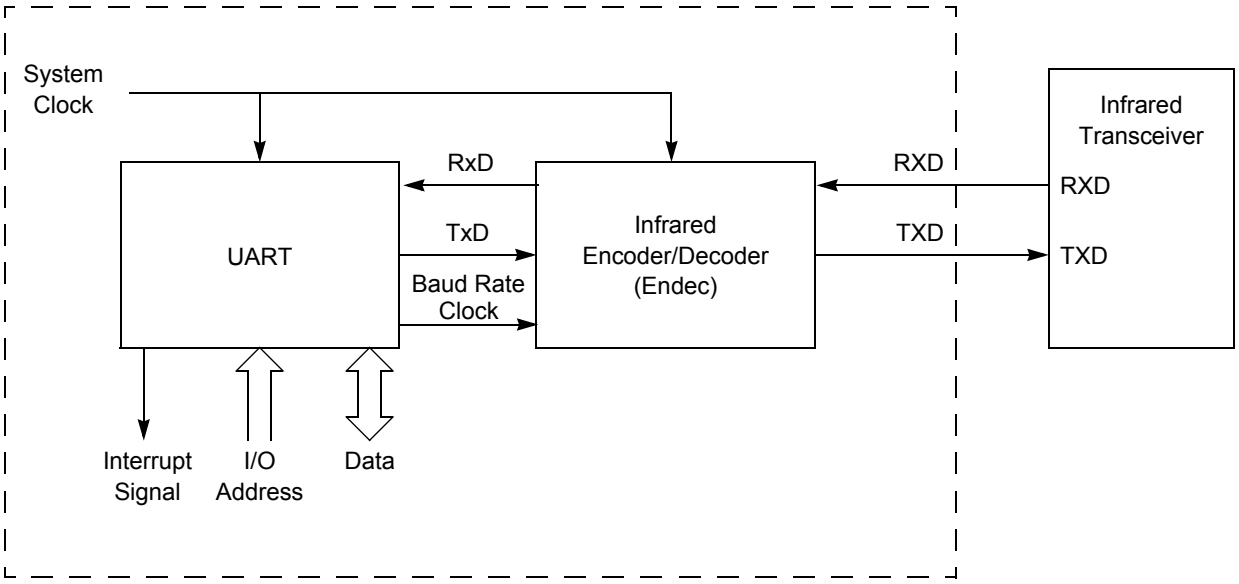


Figure 16. Infrared Data Communication System Block Diagram

Operation

When the Infrared Endec is enabled, the transmit data from the associated on-chip UART is encoded as digital signals in accordance with the IrDA standard and output to the infrared transceiver through the TXD pin. Similarly, data received from the infrared transceiver is passed to the Infrared Endec through the RXD pin, decoded by the Infrared

Receiving IrDA Data

Data received from the infrared transceiver using the IR_RXD signal through the RXD pin is decoded by the Infrared Endec and passed to the UART. The UART's baud rate clock is used by the Infrared Endec to generate the demodulated signal (RXD) that drives the UART. Each UART/Infrared data bit is 16-clocks wide. Figure 18 displays data reception. When the Infrared Endec is enabled, the UART's RXD signal is internal to the Z8 Encore! XP® F0823 Series products while the IR_RXD signal is received through the RXD pin.

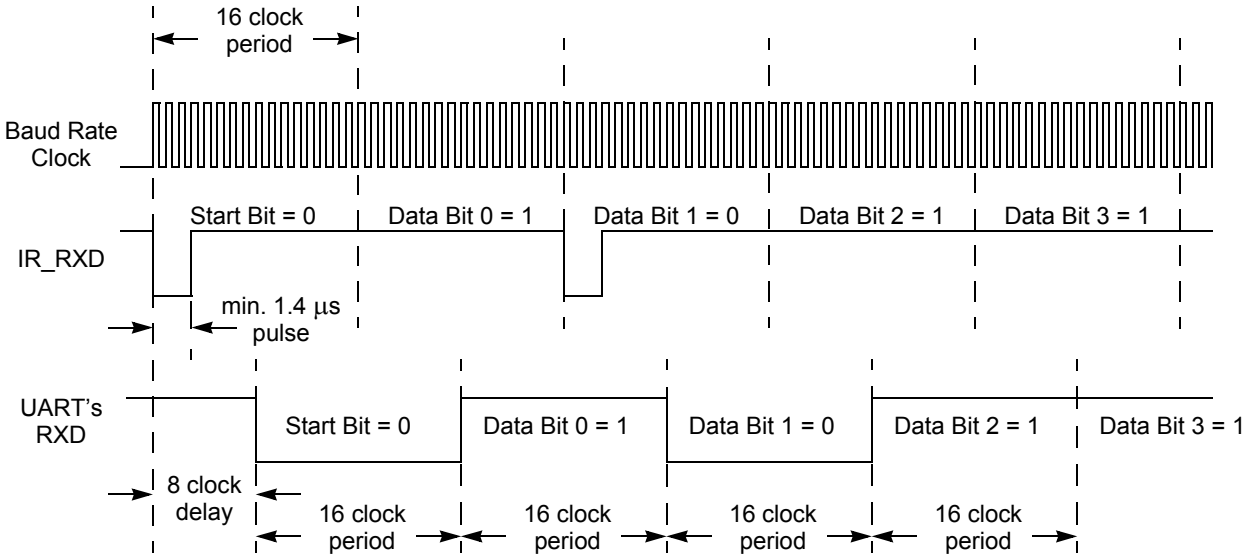


Figure 18. IrDA Data Reception

Infrared Data Reception

Caution: *The system clock frequency must be at least 1.0 MHz to ensure proper reception of the 1.4 µs minimum width pulses allowed by the IrDA standard.*

Endec Receiver Synchronization

The IrDA receiver uses a local baud rate clock counter (0 to 15 clock periods) to generate an input stream for the UART and to create a sampling window for detection of incoming pulses. The generated UART input (UART RXD) is delayed by 8 baud rate clock periods with respect to the incoming IrDA data stream. When a falling edge in the input data stream is detected, the Endec counter is reset. When the count reaches a value of 8, the UART RXD value is updated to reflect the value of the decoded data. When the count reaches 12 baud clock periods, the sampling window for the next incoming pulse opens. The window remains open until the count again reaches 8 (that is, 24 baud clock periods since the previous pulse was detected), giving the Endec a sampling window of minus four

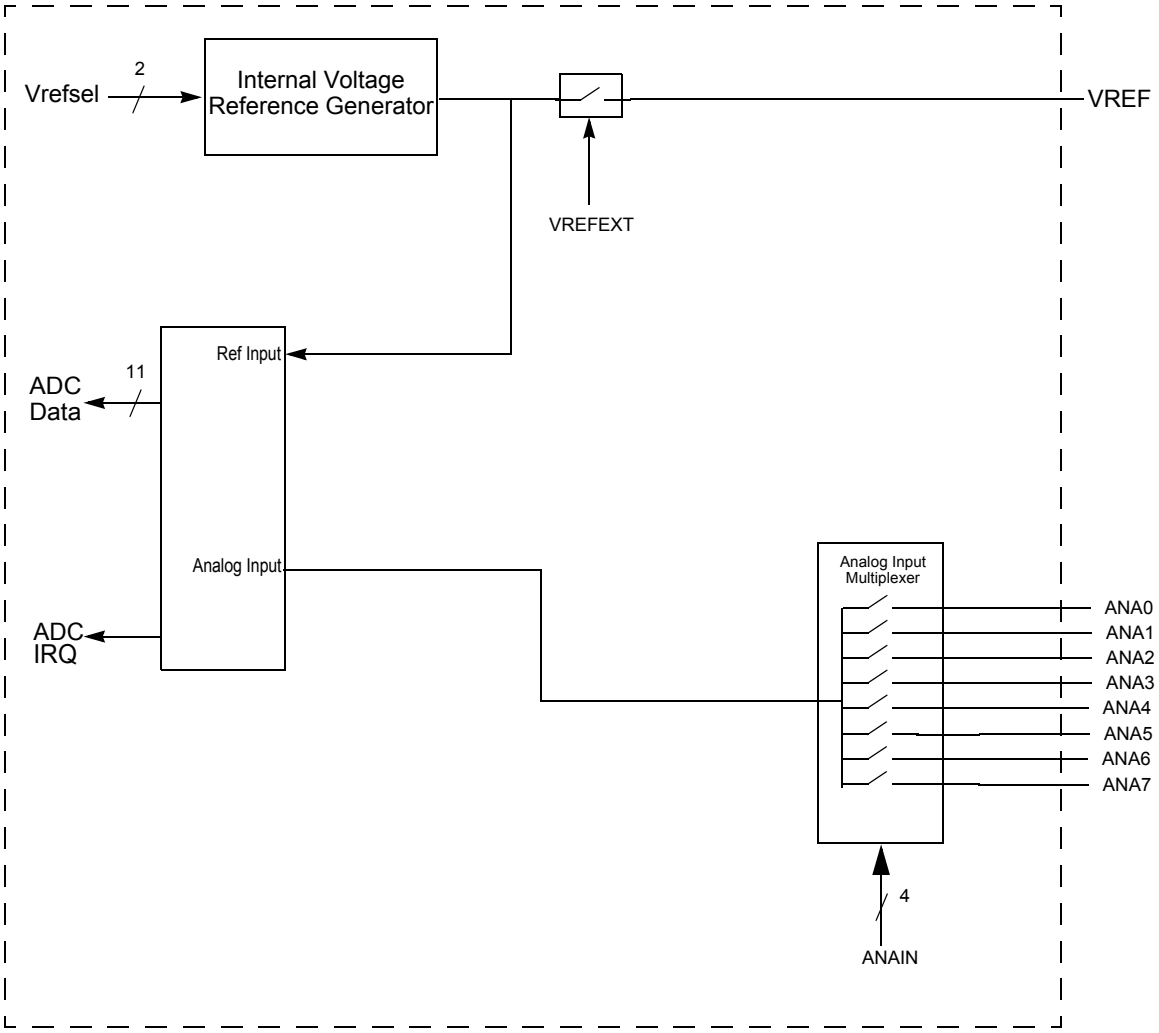


Figure 19. Analog-to-Digital Converter Block Diagram

Operation

Data Format

The output of the ADC is an 11-bit, signed, two's complement digital value. The output generally ranges from 0 to +1023, but offset errors can cause small negative values.

The ADC registers return 13 bits of data, but the two LSBs are intended for compensation use only. When the compensation routine is performed on the 13 bit raw ADC value, two

ADC Control/Status Register 1

The second ADC Control register contains the voltage reference level selection bit.

Table 73. ADC Control/Status Register 1 (ADCCTL1)

BITS	7	6	5	4	3	2	1	0
FIELD	REFSELH	Reserved						
RESET	1	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	F71H							

REFSELH—Voltage Reference Level Select High Bit; in conjunction with the Low bit (REFSELL) in ADC Control Register 0, this determines the level of the internal voltage reference; the following details the effects of {REFSELH, REFSELL}; this reference is independent of the Comparator reference

00= Internal Reference Disabled, reference comes from external pin
01= Internal Reference set to 1.0 V
10= Internal Reference set to 2.0 V (default)

ADC Data High Byte Register

The ADC Data High Byte register contains the upper eight bits of the ADC output. The output is an 11-bit two's complement value. During a single-shot conversion, this value is invalid. Access to the ADC Data High Byte register is read-only. Reading the ADC Data High Byte register latches data in the ADC Low Bits register.

Table 74. ADC Data High Byte Register (ADCD_H)

BITS	7	6	5	4	3	2	1	0
FIELD	ADCDH							
RESET	X	X	X	X	X	X	X	X
R/W	R	R	R	R	R	R	R	R
ADDR	F72H							

ADCDH—ADC Data High Byte
This byte contains the upper eight bits of the ADC output. These bits are not valid during a single-shot conversion. During a continuous conversion, the most recent conversion output is held in this register. These bits are undefined after a Reset.

Flash Memory

The products in Z8 Encore! XP® F0823 Series features either 8 KB (8192), 4 KB (4096), 2 KB (2048) or 1 KB (1024) of non-volatile Flash memory with read/write/erase capability. Flash Memory can be programmed and erased in-circuit by either user code or through the On-Chip Debugger.

The Flash Memory array is arranged in pages with 512 bytes per page. The 512-byte page is the minimum Flash block size that can be erased. Each page is divided into 8 rows of 64 bytes.

For program/data protection, the Flash memory is also divided into sectors. In the Z8 Encore! XP F0823 Series, these sectors are either 1024 bytes (in the 8 KB devices) or 512 bytes in size (all other memory sizes); each sector maps to a page. Page and sector sizes are not generally equal.

The first two bytes of the Flash Program memory are used as Flash Option Bits. For more information on their operation, see Flash Option Bits on page 141.

Table 77 describes the Flash memory configuration for each device in the Z8 Encore! XP F0823 Series. Figure 20 displays the Flash memory arrangement.

Table 77. Z8 Encore! XP F0823 Series Flash Memory Configurations

Part Number	Flash Size KB (Bytes)	Flash Pages	Program Memory Addresses	Flash Sector Size (bytes)
Z8F08x3	8 (8192)	16	0000H–1FFFH	1024
Z8F04x3	4 (4096)	8	0000H–0FFFH	512
Z8F02x3	2 (2048)	4	0000H–07FFH	512
Z8F01x3	1 (1024)	2	0000H–03FFH	512

Flash Operation Timing Using the Flash Frequency Registers

Before performing either a program or erase operation on Flash memory, you must first configure the Flash Frequency High and Low Byte registers. The Flash Frequency registers allow programming and erasing of the Flash with system clock frequencies ranging from 32 kHz (32768 Hz) through 20 MHz.

The Flash Frequency High and Low Byte registers combine to form a 16-bit value, FFREQ, to control timing for Flash program and erase operations. The 16-bit binary Flash Frequency value must contain the system clock frequency (in kHz). This value is calculated using the following equation:

$$FFREQ[15:0] = \frac{\text{System Clock Frequency (Hz)}}{1000}$$

Caution: *Flash programming and erasure are not supported for system clock frequencies below 32 kHz (32768 Hz) or above 20 MHz. The Flash Frequency High and Low Byte registers must be loaded with the correct value to ensure operation of Z8 Encore! XP® F0823 Series devices.*

Flash Code Protection Against External Access

The user code contained within the Flash memory can be protected against external access with the On-Chip Debugger. Programming the FRP Flash Option Bit prevents reading of the user code with the On-Chip Debugger. For more information, see Flash Option Bits on page 141 and On-Chip Debugger on page 151.

Flash Code Protection Against Accidental Program and Erasure

Z8 Encore! XP F0823 Series provides several levels of protection against accidental program and erasure of the Flash memory contents. This protection is provided by a combination of the Flash Option bits, the register locking mechanism, the page select redundancy and the sector level protection control of the Flash Controller.

Flash Code Protection Using the Flash Option Bits

The FRP and FWP Flash Option Bits combine to provide three levels of Flash Program Memory protection as listed in Table 78. For more information, see Flash Option Bits on page 141.

Note: *This bit only enables the crystal oscillator. Its selection as system clock must be done manually.*
0 = Crystal oscillator is enabled during reset, resulting in longer reset timing
1 = Crystal oscillator is disabled during reset, resulting in shorter reset timing

Warning: *Programming the XTLDIS bit to zero on 8-pin versions of this device prevents any further communication via the debug pin. This is due to the fact that the XIN and DBG functions are shared on pin 2 of this package. Do not program this bit to zero on 8-pin devices unless no further debugging or Flash programming is required.*

Trim Bit Address Space

All available Trim bit addresses and their functions are listed in Table 89 through Table 91.

Trim Bit Address 0000H—Reserved

Table 89. Trim Options Bits at Address 0000H

BITS	7	6	5	4	3	2	1	0
FIELD	Reserved							
RESET	U	U	U	U	U	U	U	U
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	Information Page Memory 0020H							

Note: U = Unchanged by Reset. R/W = Read/Write.

Reserved—Altering this register may result in incorrect device operation.

Trim Bit Address 0001H—Reserved

Table 90. Trim Option Bits at 0001H

BITS	7	6	5	4	3	2	1	0
FIELD	Reserved							
RESET	U	U	U	U	U	U	U	U
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	Information Page Memory 0021H							

Note: U = Unchanged by Reset. R/W = Read/Write.

On-Chip Debugger

Z8 Encore! XP® F0823 Series devices contain an integrated On-Chip Debugger (OCD) that provides advanced debugging features that include:

- Single pin interface
- Reading and writing of the register file
- Reading and writing of program and data memory
- Setting of breakpoints and watchpoints
- Executing eZ8 CPU instructions
- Debug pin sharing with general-purpose input-output function to maximize the pins available

Architecture

The on-chip debugger consists of four primary functional blocks: transmitter, receiver, auto-baud detector/generator, and debug controller. Figure 22 displays the architecture of the OCD.

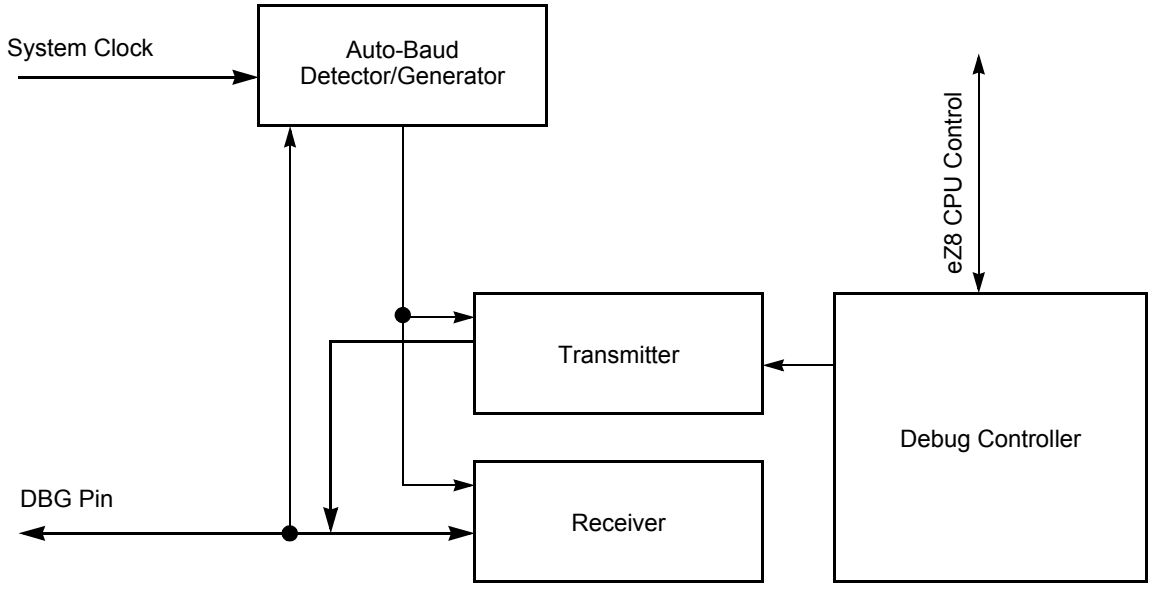


Figure 22. On-Chip Debugger Block Diagram

datastreams, the maximum recommended baud rate is the system clock frequency divided by eight. The maximum possible baud rate for asynchronous datastreams is the system clock frequency divided by four, but this theoretical maximum is possible only for low noise designs with clean signals. Table 98 lists minimum and recommended maximum baud rates for sample crystal frequencies.

Table 98. OCD Baud-Rate Limits

System Clock Frequency (MHz)	Recommended Maximum Baud Rate (kbps)	Recommended Standard PC Baud Rate (bps)	Minimum Baud Rate (kbps)
5.5296	1382.4	691,200	1.08
0.032768 (32 kHz)	4.096	2400	0.064

If the OCD receives a Serial Break (nine or more continuous bits Low) the auto-baud detector/generator resets. Reconfigure the auto-baud detector/generator by sending 80H.

OCD Serial Errors

The OCD detects any of the following error conditions on the DBG pin:

- Serial Break (a minimum of nine continuous bits Low)
- Framing Error (received Stop bit is Low)
- Transmit Collision (OCD and host simultaneous transmission detected by the OCD)

When the OCD detects one of these errors, it aborts any command currently in progress, transmits a four character long Serial Break back to the host, and resets the auto-baud detector/generator. A Framing Error or Transmit Collision may be caused by the host sending a Serial Break to the OCD. Because of the open-drain nature of the interface, returning a Serial Break break back to the host only extends the length of the Serial Break if the host releases the Serial Break early.

The host transmits a Serial Break on the DBG pin when first connecting to the Z8 Encore! XP F0823 Series devices or when recovering from an error. A Serial Break from the host resets the auto-baud generator/detector but does not reset the OCD Control register. A Serial Break leaves the device in DEBUG mode if that is the current mode. The OCD is held in Reset until the end of the Serial Break when the DBG pin returns High. Because of the open-drain nature of the DBG pin, the host sends a Serial Break to the OCD even if the OCD is transmitting a character.

Watchdog Timer Failure

In the event of a Watchdog Timer oscillator failure, a similar non-maskable interrupt-like event is issued. This event does not trigger an attendant clock switch-over, but alerts the CPU of the failure. After a Watchdog Timer failure, it is no longer possible to detect a primary oscillator failure. The failure detection circuitry does not function if the Watchdog Timer is used as the primary oscillator or if the Watchdog Timer oscillator has been disabled. For either of these cases, it is necessary to disable the detection circuitry by deasserting the WDFEN bit of the OSCCTL register.

The Watchdog Timer oscillator failure detection circuit counts system clocks while searching for a Watchdog Timer clock. The logic counts 8004 system clock cycles before determining that a failure has occurred. The system clock rate determines the speed at which the Watchdog Timer failure can be detected. A very slow system clock results in very slow detection times.

Caution: *It is possible to disable the clock failure detection circuitry as well as all functioning clock sources. In this case, the Z8 Encore! XP F0823 Series device ceases functioning and can only be recovered by Power-On Reset.*

Oscillator Control Register Definitions

The following section provides the bit definitions for the Oscillator Control register.

Oscillator Control Register

The Oscillator Control register (OSCCTL) enables/disables the various oscillator circuits, enables/disables the failure detection/recovery circuitry and selects the primary oscillator, which becomes the system clock.

The Oscillator Control register must be unlocked before writing. Writing the two step sequence E7H followed by 18H to the Oscillator Control Register unlocks it. The register is locked at successful completion of a register write to the OSCCTL.

Table 102. Oscillator Control Register (OSCCTL)

BITS	7	6	5	4	3	2	1	0
FIELD	INTEN	Reserved	WDTEN	POFEN	WDFEN	SCKSEL		
RESET	1	0	1	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	F86H							

Table 110. CPU Control Instructions (Continued)

Mnemonic	Operands	Instruction
SCF	—	Set Carry Flag
SRP	src	Set Register Pointer
STOP	—	STOP Mode
WDT	—	Watchdog Timer Refresh

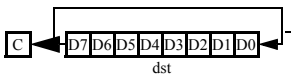
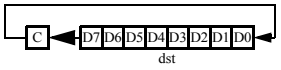
Table 111. Load Instructions

Mnemonic	Operands	Instruction
CLR	dst	Clear
LD	dst, src	Load
LDC	dst, src	Load Constant to/from Program Memory
LDCI	dst, src	Load Constant to/from Program Memory and Auto-Increment Addresses
LDE	dst, src	Load External Data to/from Data Memory
LDEI	dst, src	Load External Data to/from Data Memory and Auto-Increment Addresses
LDWX	dst, src	Load Word using Extended Addressing
LDX	dst, src	Load using Extended Addressing
LEA	dst, X(src)	Load Effective Address
POP	dst	Pop
POPX	dst	Pop using Extended Addressing
PUSH	src	Push
PUSHX	src	Push using Extended Addressing

Table 112. Logical Instructions

Mnemonic	Operands	Instruction
AND	dst, src	Logical AND
ANDX	dst, src	Logical AND using Extended Addressing
COM	dst	Complement
OR	dst, src	Logical OR

Table 115. eZ8 CPU Instruction Summary (Continued)

Assembly Mnemonic	Symbolic Operation	Address Mode dst	Address Mode src	Opcode(s) (Hex)	Flags C	Z	S	V	D	H	Fetch Cycles	Instr. Cycles
OR dst, src	dst ← dst OR src	r	r	42	–	*	*	0	–	–	2	3
		r	Ir	43							2	4
		R	R	44							3	3
		R	IR	45							3	4
		R	IM	46							3	3
		IR	IM	47							3	4
ORX dst, src	dst ← dst OR src	ER	ER	48	–	*	*	0	–	–	4	3
		ER	IM	49							4	3
POP dst	dst ← @SP SP ← SP + 1	R		50	–	–	–	–	–	–	2	2
		IR		51							2	3
POPX dst	dst ← @SP SP ← SP + 1	ER		D8	–	–	–	–	–	–	3	2
PUSH src	SP ← SP – 1 @SP ← src	R		70	–	–	–	–	–	–	2	2
		IR		71							2	3
		IM		IF70							3	2
PUSHX src	SP ← SP – 1 @SP ← src	ER		C8	–	–	–	–	–	–	3	2
RCF	C ← 0			CF	0	–	–	–	–	–	1	2
RET	PC ← @SP SP ← SP + 2			AF	–	–	–	–	–	–	1	4
RL dst		R		90	*	*	*	*	–	–	2	2
		IR		91							2	3
RLC dst		R		10	*	*	*	*	–	–	2	2
		IR		11							2	3

Flags Notation:	* = Value is a function of the result of the operation. – = Unaffected X = Undefined	0 = Reset to 0 1 = Set to 1

On-Chip Peripheral AC and DC Electrical Characteristics

Table 122. Power-On Reset and Voltage Brownout Electrical Characteristics and Timing

		T_A = -40 °C to +105 °C				
Symbol	**Parameter**	**Minimum**	**Typical[1]**	**Maximum**	**Units**	**Conditions**
V_{POR}	Power-On Reset Voltage Threshold	2.20	2.45	2.70	V	$V_{DD} = V_{POR}$
V_{VBO}	Voltage Brownout Reset Voltage Threshold	2.15	2.40	2.65	V	$V_{DD} = V_{VBO}$
	V_{POR} to V_{VBO} hysteresis		50	75	mV	
	Starting V_{DD} voltage to ensure valid Power-On Reset.	–	V_{SS}	–	V	
T_{ANA}	Power-On Reset Analog Delay	–	70	–	µs	$V_{DD} > V_{POR}$; T_{POR} Digital Reset delay follows T_{ANA}
T_{POR}	Power-On Reset Digital Delay		16		µs	66 Internal Precision Oscillator cycles + IPO startup time (T_{IPOST})
T_{SMR}	Stop Mode Recovery		16		µs	66 Internal Precision Oscillator cycles
T_{VBO}	Voltage Brownout Pulse Rejection Period	–	10	–	µs	Period of time in which $V_{DD} < V_{VBO}$ without generating a Reset.
T_{RAMP}	Time for V_{DD} to transition from V_{SS} to V_{POR} to ensure valid Reset	0.10	–	100	ms	
T_{SMP}	Stop Mode Recovery pin pulse rejection period		20		ns	For any SMR pin or for the Reset pin when it is asserted in STOP mode.

[1]Data in the typical column is from characterization at 3.3 V and 30 °C. These values are provided for design guidance only and are not tested in production.

Part Number	Flash	RAM	I/O Lines	Interrupts	16-Bit Timers w/PWM	10-Bit A/D Channels	UART with IrDA	Description
Z8 Encore! XP with 8 KB Flash								
Standard Temperature: 0 °C to 70 °C								
Z8F0813PB005SC	8 KB	1 KB	6	12	2	0	1	PDIP 8-pin package
Z8F0813QB005SC	8 KB	1 KB	6	12	2	0	1	QFN 8-pin package
Z8F0813SB005SC	8 KB	1 KB	6	12	2	0	1	SOIC 8-pin package
Z8F0813SH005SC	8 KB	1 KB	16	18	2	0	1	SOIC 20-pin package
Z8F0813HH005SC	8 KB	1 KB	16	18	2	0	1	SSOP 20-pin package
Z8F0813PH005SC	8 KB	1 KB	16	18	2	0	1	PDIP 20-pin package
Z8F0813SJ005SC	8 KB	1 KB	24	18	2	0	1	SOIC 28-pin package
Z8F0813HJ005SC	8 KB	1 KB	24	18	2	0	1	SSOP 28-pin package
Z8F0813PJ005SC	8 KB	1 KB	24	18	2	0	1	PDIP 28-pin package
Extended Temperature: -40 °C to 105 °C								
Z8F0813PB005EC	8 KB	1 KB	6	12	2	0	1	PDIP 8-pin package
Z8F0813QB005EC	8 KB	1 KB	6	12	2	0	1	QFN 8-pin package
Z8F0813SB005EC	8 KB	1 KB	6	12	2	0	1	SOIC 8-pin package
Z8F0813SH005EC	8 KB	1 KB	16	18	2	0	1	SOIC 20-pin package
Z8F0813HH005EC	8 KB	1 KB	16	18	2	0	1	SSOP 20-pin package
Z8F0813PH005EC	8 KB	1 KB	16	18	2	0	1	PDIP 20-pin package
Z8F0813SJ005EC	8 KB	1 KB	24	18	2	0	1	SOIC 28-pin package
Z8F0813HJ005EC	8 KB	1 KB	24	18	2	0	1	SSOP 28-pin package
Z8F0813PJ005EC	8 KB	1 KB	24	18	2	0	1	PDIP 28-pin package
Replace C with G for Lead-Free Packaging								

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